

# **Cascadable Silicon Bipolar MMIC Amplifier**

# **Technical Data**

#### **MSA-0470**

#### Features

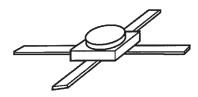
- Cascadable 50  $\Omega$  Gain Block
- **3 dB Bandwidth:** DC to 4.0 GHz
- 12.5 dBm Typical P<sub>1 dB</sub> at 1.0 GHz
- 8.5 dB Typical Gain at 1.0 GHz
- Unconditionally Stable (k>1)
- Hermetic Gold-ceramic Microstrip Package

#### **Description**

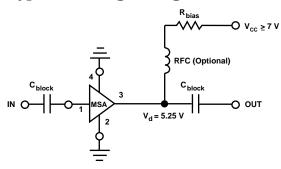
The MSA-0470 is a high performance silicon bipolar Monolithic Microwave Integrated Circuit (MMIC) housed in a hermetic, high reliability package. This MMIC is designed for use as a general purpose 50  $\Omega$  gain block. Typical applications include narrow and broad band IF and RF amplifiers in industrial and military applications.

The MSA-series is fabricated using Agilent's 10 GHz  $f_T$ , 25 GHz  $f_{MAX}$ , silicon bipolar MMIC process which uses nitride self-alignment, ion implantation, and gold metallization to achieve excellent performance, uniformity and reliability. The use of an external bias resistor for temperature and current stability also allows bias flexibility.

### 70 mil Package



#### **Typical Biasing Configuration**



#### **MSA-0470 Absolute Maximum Ratings**

Parameter	Absolute Maximum <sup>[1]</sup>				
Device Current	100 mA				
Power Dissipation <sup>[2,3]</sup>	650 mW				
RF Input Power	+13 dBm				
Junction Temperature	200°C				
Storage Temperature	-65 to 200°C				

Thermal Resistance<sup>[2,4]</sup>:

 $\theta_{jc} = 115^{\circ}C/W$ 

#### Notes:

- 1. Permanent damage may occur if any of these limits are exceeded.
- 2.  $T_{CASE} = 25^{\circ}C.$
- 3. Derate at 8.7 mW/°C for  $T_C > 125^{\circ}C$ .
- 4. The small spot size of this technique results in a higher, though more accurate determination of  $\theta_{jc}$  than do alternate methods. See MEASURE-MENTS section "Thermal Resistance" for more information.

#### Parameters and Test Conditions: $I_{d}$ = 50 mA, $Z_{0}$ = 50 $\Omega$ Symbol Units Min. Typ. Max. Gp Power Gain $(|S_{21}|^2)$ f = 0.1 GHzdB 7.5 8.5 9.5 $\Delta G_P$ **Gain Flatness** f = 0.1 to 2.5 GHz dB $\pm 0.6$ $\pm 1.0$ 3 dB Bandwidth GHz 4.0 f3 dB Input VSWR f = 0.1 to 2.5 GHz 1.7:1 VSWR Output VSWR f = 0.1 to 2.5 GHz 2.0:1 NF 50 $\Omega$ Noise Figure f = 1.0 GHzdB 6.5 $P_{1 \, dB}$ Output Power at 1 dB Gain Compression f = 1.0 GHzdBm 12.5 Third Order Intercept Point f = 1.0 GHz25.5 IP<sub>3</sub> dBm **Group Delay** f = 1.0 GHz125 tD psec $V_{d}$ **Device Voltage** V 4.75 5.25 5.75 dV/dT **Device Voltage Temperature Coefficient** mV/°C -8.0

#### **Electrical Specifications**<sup>[1]</sup>, $T_A = 25^{\circ}C$

Note:

1. The recommended operating current range for this device is 30 to 70 mA. Typical performance as a function of current is on the following page.

Freq. GHz	S <sub>11</sub>		S <sub>21</sub>		S <sub>12</sub>			S <sub>22</sub>		
	Mag	Ang	dB	Mag	Ang	dB	Mag	Ang	Mag	Ang
0.1	.18	179	8.5	2.67	176	-16.4	.151	1	.10	-14
0.2	.18	179	8.5	2.67	172	-16.4	.151	2	.10	-30
0.4	.18	179	8.5	2.67	163	-16.4	.152	3	.13	-50
0.6	.17	-179	8.5	2.65	155	-16.2	.155	5	.16	-67
0.8	.16	-176	8.4	2.64	147	-16.1	.158	8	.19	-79
1.0	.16	-174	8.3	2.61	138	-15.9	.161	6	.22	-90
1.5	.16	-166	8.2	2.56	117	-15.5	.169	9	.29	-111
2.0	.21	-163	7.8	2.46	97	-14.6	.186	9	.33	-131
2.5	.26	-162	7.3	2.33	83	-13.8	.204	12	.36	-142
3.0	.32	-170	6.5	2.12	65	-13.5	.212	10	.40	-156
3.5	.37	-177	5.7	1.93	38	-13.2	.220	7	.40	-164
4.0	.40	175	4.7	1.73	33	-12.6	.234	3	.40	-170
4.5	.41	166	3.9	1.57	20	-12.4	.239	-1	.39	-173
5.0	.42	155	3.1	1.44	7	-11.9	.255	-6	.37	-176

MSA-0470 Typical Scattering Parameters (Z<sub>0</sub> = 50  $\Omega$ , T<sub>A</sub> = 25°C, I<sub>d</sub> = 50 mA)

A model for this device is available in the DEVICE MODELS section.

## Typical Performance, $T_A = 25^{\circ}C$

(unless otherwise noted)

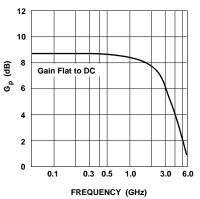
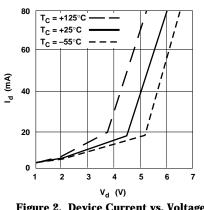


Figure 1. Typical Power Gain vs. Frequency,  $T_A$  = 25°C,  $I_d$  = 50 mA.



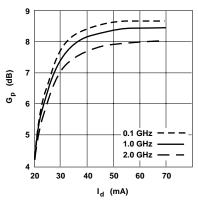


Figure 2. Device Current vs. Voltage.



7.5

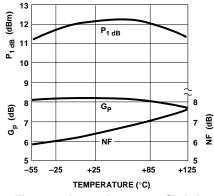


Figure 4. Output Power at 1 dB Gain **Compression, NF and Power Gain vs.** Case Temperature, f = 1.0 GHz,  $I_{d} = 50 \text{ mÅ}.$ 

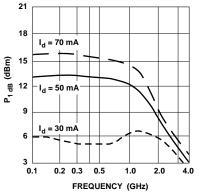


Figure 5. Output Power at 1 dB Gain **Compression vs. Frequency.** 

7.0 NF (dB) 6.5 6.0 I<sub>d</sub> = 30 mA

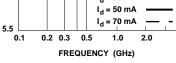
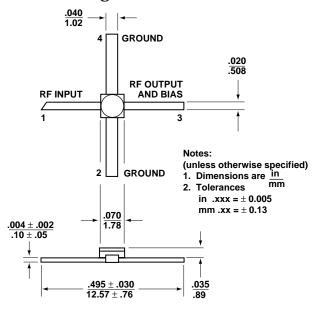


Figure 6. Noise Figure vs. Frequency.



## 70 mil Package Dimensions



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